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Single RS485 isolated transceiver module, SMD package

RoHS

FEATURES

- Small size, SMD package
- Integrated highly efficient isolated DC-DC converter
- High baud rate of up to 19200bps
- Two-port isolation test voltage (2.5kVDC)
- Operating ambient temperature range: -40 $^{\circ}$ C to +85 $^{\circ}$ C
- The bus supports maximum 64 nodes
- Set isolation and ESD bus protection in one
- EN60950 approval

The main function of the TD321S485 / TD521S485 series is to convert a logic level signal into isolated RS485 differential level signals. The special integrated IC technology of the RS485 transceiver achieves isolation between the power supply and the signal lines isolation, does RS485 communication and protects the bus all in one and the same module. The product's isolated power supply withstands a test voltage of up to 2500VDC. The Products are using pick and place SMD technology, thus enabling the use of fully automated processing. Also, they can easily be embedded in the user's end equipment, to achieve fully functional RS485 network connections.

Selection Guide								
Certification	Part No.	Mark	Power input (VDC)	Baud rate (bps)	Static Current (mA)	Max. Operating Current (mA)	lsolated power output (typ.)(VDC)	Number of Nodes
CF.	TD321S485	321SR	3.15-3.45	19200	30	130	5	64
CE	TD521S485	521SR	4.75-5.25	19200	35	130	5	64

Absolute Limits					
Item	Operating Conditions	Min.	Тур.	Max.	Unit
	3.3V series	-0.7		5	VDC
Input Surge Voltage (1sec.max.)	5.0V series	-0.7		7	
Pin Soldering Temperature	Soldering time 10s max.			300	°C
Reflow Soldering Temperature			Peak temp. \leq 245°C, duration \leq 60s max.at 21 For details, please refer to IPC/JEDEC J-STD-02		

3.3V Input S	pecificatior	าร					
Item		Symbol	Min.	Тур.	Max.	Unit	
Power Supply Inpu	ut Voltage	VCC	3.15	3.3	3.45		
TVD Logic Loval	High-level	Vih		3.3			
TXD Logic Level	Low-level	Vil		0		VDC	
	High-level	Voh	VCC-0.4	3.1	-		
RXD Logic Level	Low-level	Vol	0	0.2	0.4		
TXD Drive Current CON Drive Current RXD Output Current		л			5		
		ICON			5	mA	
		lR 3		3.5			
Serial Interface		Compatible with + 3.3 V UART interface only					

5.0V Input S	pecificatior	ns					
ltem		Symbol	Min.	Тур.	Max.	Unit	
Power Supply Input Voltage		VCC	4.75	5	5.25		
TYD Logic Lovel	High-level	Vih		5		-	
TXD Logic Level	Low-level	Vil		0		VDC	
	High-level	Voн	VCC-0.4	4.8			
RXD Logic Level	Low-level	Vol	0	0.2	0.4		
TXD Drive Current		h			5		
CON Drive Current RXD Output Current		Ісон			5	mA	
		lR	le 3.5		3.5		
Serial Interface		Compatible with + 5 V UART interface only					

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Industrial Bus

TD5(3)21S485 Series

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Transmissio	Transmission Specifications					
Item		Symbol	Min.	Тур.	Max.	Unit
Data Delay	TXD Transmitter Delay	tτ			50	
Dala Delay	RXD Receiver Delay	t _R		50	50	US
Handoff Delay				5	18	

Output Specifications				
Symbol	Min.	Тур.	Max.	Unit
Vdiff(d), RL=54 Ω	1.5	2	-	VDC
	54			Ω
-7V≪Vcм≪+12V	96			k o
		24		- k Ω
Nominal input voltage	4.9	5	5.3	VDC
	ESD protection			
	Valif(α), Rι=54 Ω -7V≪Vcм≪+12V	Vairr(d), RL=54 Ω 1.5 -7V≤VcM≤+12V 96	Vdiff(d), RL=54 Ω 1.5 2 -7V≤VcM≤+12V 96 -7V≤VcM≤+12V 96 Nominal input voltage 4.9 5	Vdiff(d), RL=54 Ω 1.5 2 -7V≤VcM≤+12V 96 -7V≤VcM≤+12V 96 Nominal input voltage 4.9 5 5.3

Note: *Isolated output power pins are for external pull-up, pull-down resistors only (recommended maximum current <25mA) and are not meant for any other purpose.

Transceiver Control		Input		Output	
	CON	TXD	А	В	RXD
Send status	0	1	1	0	1
	0	0	0	1	1
	CON	VA-VB	RXD		
	1	≥-10mV	1		
Receive status [®]	1	≤-200m V	0		
	1	-200mV <va-vb<-10mv< td=""><td></td><td>Undefined state</td><td>)</td></va-vb<-10mv<>		Undefined state)

Note: DReceiving threshold varies with Vcc will produce subtle error.

General Specifications		
Item	Operating Conditions	Value
Isolation Test	Electric Strength Test for 1 minute, leakage current <1mA	2500VDC
Insulation Resistance	At 500VDC	1000M Ω (input-output)
Operating Temperature		-40℃ to +85℃
Transportation and Storage Temperature		-50 ℃ to +105℃
Operating Humidity	Non-condensing	10% - 90%
Safety Standard		EN60950
Safety Certification		E1100950
Safety Class		CLASS III

Mechanical Specifications			
Dimensions	SMD10		
Weight	1.9g (Тур.)		
Cooling Method	Free air convection		

Electror	lectromagnetic Compatibility (EMC)				
Emissions CE CISPR32/EN55032 CLASS A (see Fig. 3)		CISPR32/EN55032 CLASS A (see Fig. 3)			
	ESD	IEC/EN 61000-4-2 Contact ±4kV (A, B port)	Perf. Criteria B		
	ESD	IEC/EN 61000-4-2 Contact ±8kV (see Fig.2, A, B port)	Perf. Criteria B		
leonou unita (EFT	IEC/EN 61000-4-4 ±2kV (see Fig.2, A, B port)	Perf. Criteria B		
Immunity	<u>Currence</u>	IEC/EN 61000-4-5 ±2kV (without external components, A, B port)	Perf. Criteria B		
	Surge	IEC/EN 61000-4-5 ±4kV (see Fig.2, A, B port)	Perf. Criteria B		
	CS	IEC/EN 61000-4-6 3Vr.m.s	Perf. Criteria A		

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Industrial Bus

TD5(3)21S485 Series

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Application Precautions

- 1. Carefully read and follow the instructions before use; contact our technical support if you have any question;
- 2. Do not use the product in hazardous areas;
- 3. Use only DC power supply source for this product. 220V AC power supply is prohibited;
- 4. It is strictly forbidden to disassemble the product privately in order to avoid product failure or malfunction.

After-sales service

- 1. Factory inspection and quality control are strictly enforced before shipping any product; please contact your local representative or our technical support if you experience any abnormal operation or possible failure of the module;
- 2. The products have a 3-year warranty period, from the date of shipment. The product will be repaired or exchanged free of charge within the warranty period for any quality problem that occurs under normal use.

Applied circuit

Refer to the RS485 Isolated Industrial Bus Interface Module Application Manual.

Design Reference

1. Typical application circuit

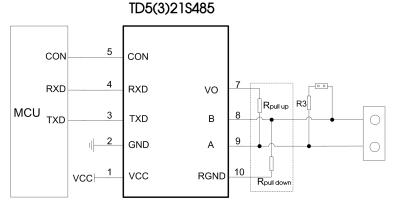


Fig. 1: Typical application

Figure 1 shows a typical connection circuit for the isolated transceiver module TD321S485 and TD521S485. The TD521S485 module's power supply must be 5V and match the module's TXD, RXD and CON pin interface level of 5V (not supporting any 3.3V system levels). Accordingly, TD321S485 module's power supply must be 3.3V and match the module's TXD, RXD and CON pin interface level of 3.3V (not supporting any 5V system levels).

The module has a built-in $24k\Omega$ pull-down resistor, which under normal circumstances meets the demand for the use of internal pull-up and pull-down resistors. Depending on the actual circuit, the use of additional external R pull-up and R pull-down resistor may be chosen.

2. Recommended port protection circuit

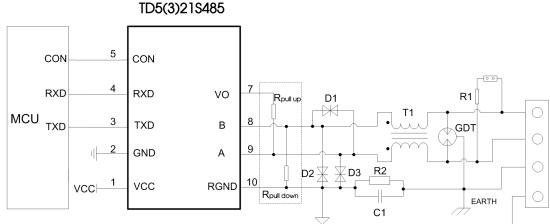


Fig. 2: Port protection circuit for harsh environments

Note: Ground shield of twisted wire pair reliably.



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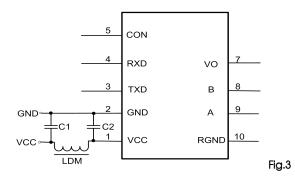
Industrial Bus TD5(3)21S485 Series



Recommended components and values:

-								
	Component	Recommended part, value	Component	Recommended part, value				
	RI	120 Ω	R2	1Μ Ω				
	C1	1nF, 2kV	Dl	SMBJ12CA				
	TI	ACM2520-301-2P	D2, D3	SMBJ6.5CA				
	GDT	S30-A90X	Rpull up, Rpull down	Select matching network resistance appropriately				

As the modules internal A / B lines come with its own ESD protection, which generally satisfy most application environments without the need for additional ESD protection devices, as shown in the typical circuit in Figure 1. For harsh and noisy application environments such as motors, high voltage/current switches, lightning and similar however, we recommended that the user protects the module's A / B lines with additional measures and external components such as TVS tube, common mode inductors, Gas discharge tube, shielded twisted pair of wires with the same single network Earth point. Figure 2 shows our recommended circuit diagram for such type of applications with components and values given in the table above. This recommendation is for reference only and may have to be adapted accordingly with appropriate component values in order to match the actual situation and application.



Components	Recommended parameters
C1, C2	1uF/16V
LDM	CD43-12uH

3. Precautions

1) Hot-swap is not supported.

2) TD521S485 is for 5V TTL level only (not compatible with 3.3V); TD321S485 is for 3.3V TTL level only (not compatible with 5V).

3) Pin6 are not drawn. Please leave pin 10 open if unused.

4) We recommend using a shielded twisted pair of wires for the Data transmission line and using same single point earth connection for each of the networks.

5) From the truth table characteristics, it can be derived that the isolated RS-485 transceiver module's CON pin is low to send data and high when receiving data. Note that the general 485 transceiver chip control level is exactly the opposite, therefore, if the customer desires to change the level to the ordinary 485 transceiver chip control level, we recommend using a transistor circuit between the MCU and the CON feed to reverse this signal.

6) Reference the truth table characteristics: When the A / B line differential voltage of the series of embedded isolated RS-485 transceiver module is \geq -10mV, the modules receiving level is high and when the A / B line differential voltage is \leq -200mV the modules receiving level is low; the modules receiving level is undefined when the A / B line differential voltage is greater than -200mV but less than -10mV, so the design is to ensure that the module will not be receiving this state. Depending on the actual situation, it is up to the user of the RS-485 network design or application to decide whether to add a 120 Ω termination resistor. Avoiding data communication errors: Regardless if the RS-485 network is static or dynamic, it is essential to avoid that the differential voltage of A / B line ever comes between -200mV and -10mV. **4.** For additional information, please refer to our application note on www.mornsun-power.com

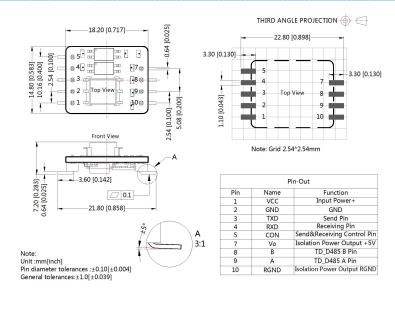
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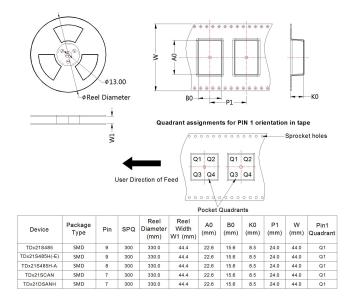
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Dimensions and Recommended Layout

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Package diagram:



Notes:

- 1. For additional information on Product Packaging please refer to <u>www.mornsun-power.com</u>. The Packaging bag number: 58240012;
- 2. Unless otherwise specified, parameters in this datasheet were measured under the conditions of Ta=25°C, humidity<75%RH with nominal input voltage and rated output load;
- 3. There may be slight colour difference on the surface of the PCB, which is normal and does not affect product use;
- 4. All index testing methods in this datasheet are based on Company's corporate standards;
- 5. The above are the performance indicators of the product models listed in this datasheet. Some indicators of non-standard models will exceed the above requirements. For details, please contact our technical staff;
- 6. We can provide product customization service;
- 7. Products are related to laws and regulations: see "Features" and "EMC";
- 8. Our products shall be classified according to ISO14001 and related environmental laws and regulations, and shall be handled by qualified units.

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